

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

In re:

Applicant

LANDA, David, et al.

Serial No.

09/849,467

Filed

May 4, 2001

For

PROCESS FOR MAKING ADHESIVE

BONDED SINTERED PLATES

Examiner

KEEHAN, Christopher M

Art Unit

1712

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Honorable Sir:

April 29, 2004

LETTER

In response to the August 20, 2003 Office Action and the April 13, 2004 Notice of Non-Compliant Amendment, please amend the application as follows:

IN THE SPECIFICATION

On page 4, line 2, replace "450 F" with -- 1220° F --.

IN THE CLAIMS:

Please cancel claims 12-23.

24. (New) A method for making sintered plates comprising:

providing a metal core of a first thickness having a top surface and a bottom surface; cleaning the entire top surface;